



InGaP HBT 1 WATT POWER AMPLIFIER, 0.4 - 2.2 GHz

Typical Applications

The HMC452ST89 / HMC452ST89E is ideal for applications requiring a high dynamic range amplifier:

- GSM, GPRS & EDGE
- CDMA & W-CDMA
- CATV/Cable Modem
- Fixed Wireless

Features

- Output IP3: +49 dBm
- 21 dB Gain @ 400 MHz
- 9 dB Gain @ 2100 MHz
- 50% PAE @ +31 dBm Pout
- +25 dBm CDMA2000 Channel Power @ -45 dBc ACP
- Included in the HMC-DK002 Designer's Kit

Functional Diagram



General Description

The HMC452ST89 & HMC452ST89E are high dynamic range GaAs InGaP HBT 1 Watt MMIC power amplifiers operating from 0.4 to 2.2 GHz and packaged in industry standard SOT89 packages. Utilizing a minimum number of external components and a single +5V supply, the amplifier output IP3 can be optimized to +45 dBm at 0.4 GHz or +49 dBm at 2.1 GHz. The high output IP3 and PAE make the HMC452ST89 & HMC452ST89E ideal power amplifiers for Cellular/PCS/3G and Fixed Wireless applications.

Electrical Specifications, $T_A = +25^\circ\text{C}$, $V_S = +5\text{V}$ [1]

| Parameter | Min. | Typ. | Max. | Min. | Typ. | Max. | Min. | Typ. | Max. | Min. | Typ. | Max. | Min. | Typ. | Max. | Units |
|---|-----------|-------|------|-----------|-------|------|-----------|-------|------|-------------|-------|------|-------------|-------|------|---------|
| Frequency Range | 400 - 410 | | | 450 - 496 | | | 810 - 960 | | | 1710 - 1990 | | | 2010 - 2170 | | | MHz |
| Gain | 19 | 21 | | 18 | 20 | | 13.5 | 15.5 | | 7 | 9.5 | | 7 | 9 | | dB |
| Gain Variation Over Temperature | | 0.012 | 0.02 | | 0.012 | 0.02 | | 0.012 | 0.02 | | 0.012 | 0.02 | | 0.012 | 0.02 | dB / °C |
| Input Return Loss | | 22 | | | 16 | | | 13 | | | 13 | | | 20 | | dB |
| Output Return Loss | | 11 | | | 11 | | | 14 | | | 15 | | | 15 | | dB |
| Output Power for 1dB Compression (P1dB) | 27 | 30 | | 27 | 30 | | 27.5 | 30.5 | | 28 | 31 | | 28.5 | 31.5 | | dBm |
| Saturated Output Power (Psat) | | 30.5 | | | 30.5 | | | 31.5 | | | 31.5 | | | 32 | | dBm |
| Output Third Order Intercept (IP3) [2] | 42 | 45 | | 42 | 45 | | 44 | 47 | | 45 | 48 | | 46 | 49 | | dBm |
| Noise Figure | | 6.5 | | | 7 | | | 6.5 | | | 6.5 | | | 6.5 | | dB |
| Supply Current (Icq) | | 510 | | | 510 | | | 510 | | | 510 | | | 510 | | mA |

[1] Specifications and data reflect HMC452ST89 measured using the respective application circuits for each designated frequency band found herein. Contact the HMC Applications Group for assistance in optimizing performance for your application.

[2] Two-tone input power of 0 dBm per tone, 1 MHz spacing.

For price, delivery and to place orders: Hittite Microwave Corporation, 20 Alpha Road, Chelmsford, MA 01824

Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com

Application Support: Phone: 978-250-3343 or apps@hittite.com



Broadband Gain & Return Loss @ 400 MHz



Gain vs. Temperature @ 400 MHz



Input Return Loss vs. Temperature @ 400 MHz



Output Return Loss vs. Temperature @ 400 MHz



P1dB vs. Temperature @ 400 MHz



Psat vs. Temperature @ 400 MHz

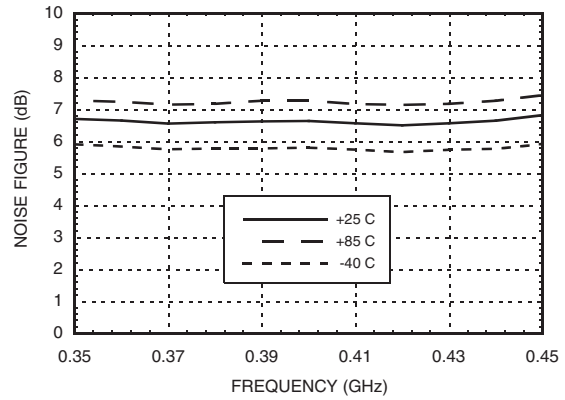




Output IP3 vs. Temperature @ 400 MHz



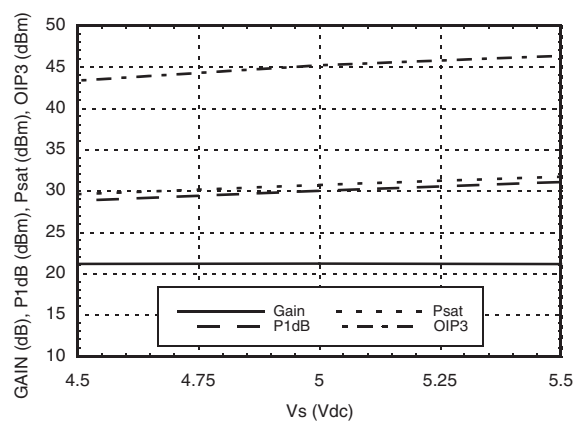
Noise Figure vs. Temperature @ 400 MHz



Reverse Isolation vs. Temperature @ 400 MHz



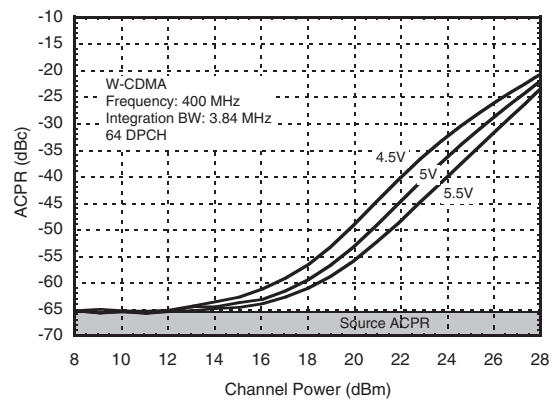
Gain, Power & IP3 vs. Supply Voltage @ 400 MHz



Power Compression @ 400 MHz



ACPR vs. Supply Voltage @ 400 MHz W-CDMA, 64 DPCH





Broadband Gain & Return Loss @ 470 MHz



Gain vs. Temperature @ 470 MHz



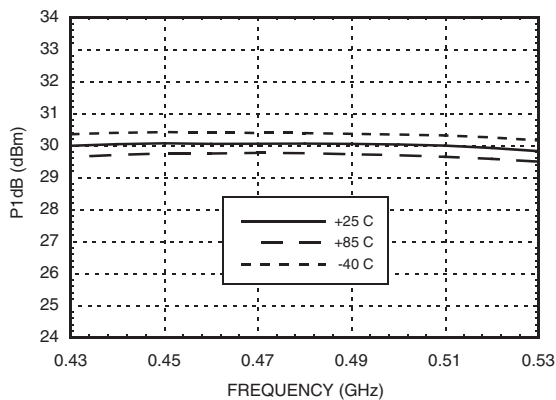
Input Return Loss vs. Temperature @ 470 MHz



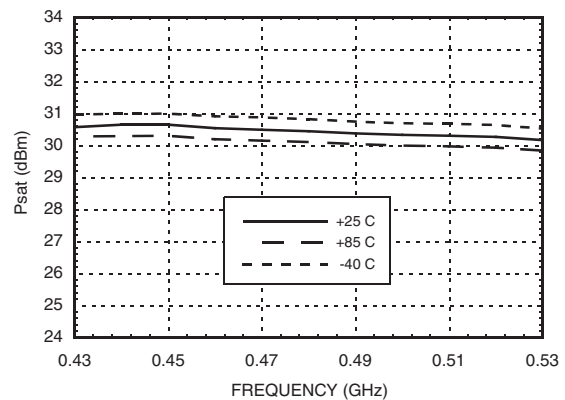
Output Return Loss vs. Temperature @ 470 MHz



P1dB vs. Temperature @ 470 MHz



Psat vs. Temperature @ 470 MHz



Output IP3 vs. Temperature @ 470 MHz



Noise Figure vs. Temperature @ 470 MHz



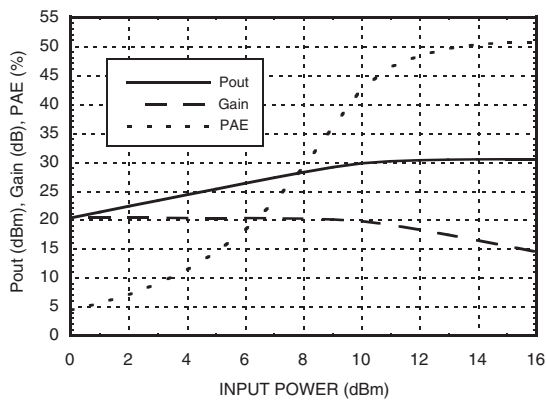
Reverse Isolation vs. Temperature @ 470 MHz



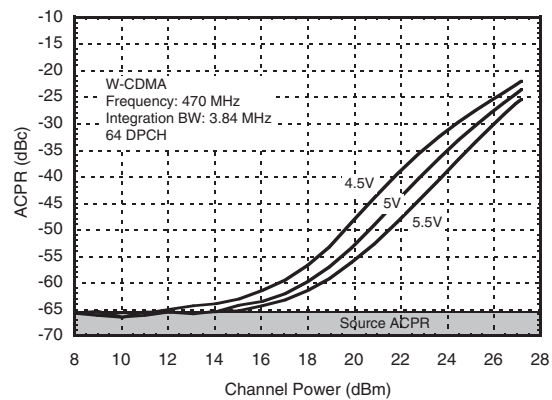
Gain, Power & IP3 vs. Supply Voltage @ 470 MHz



Power Compression @ 470 MHz



ACPR vs. Supply Voltage @ 470 MHz W-CDMA, 64 DPCH





Broadband Gain & Return Loss @ 900 MHz



Gain vs. Temperature @ 900 MHz



Input Return Loss vs. Temperature @ 900 MHz



Output Return Loss vs. Temperature @ 900 MHz



P1dB vs. Temperature @ 900 MHz



Psat vs. Temperature @ 900 MHz





Output IP3 vs. Temperature @ 900 MHz



Noise Figure vs. Temperature @ 900 MHz



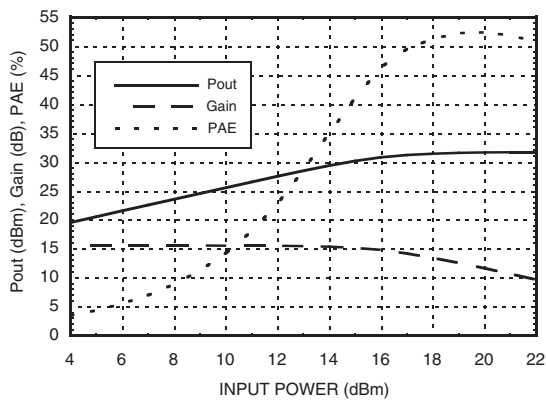
Reverse Isolation vs. Temperature @ 900 MHz



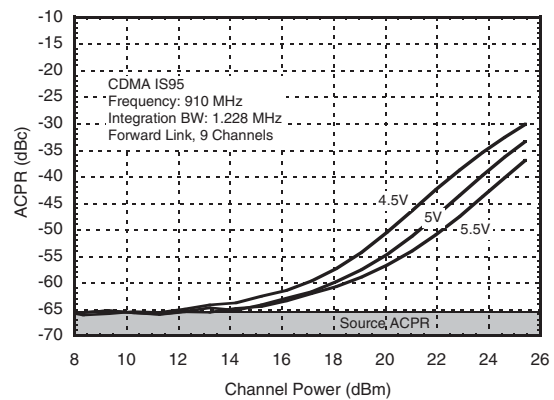
Gain, Power & IP3 vs. Supply Voltage @ 900 MHz



Power Compression @ 900 MHz

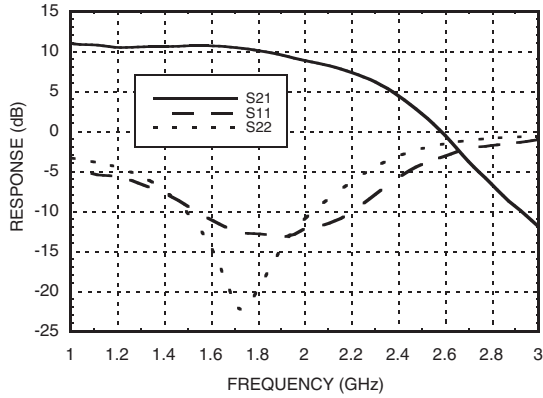


ACPR vs. Supply Voltage @ 910 MHz CDMA IS95, 9 Channels Forward

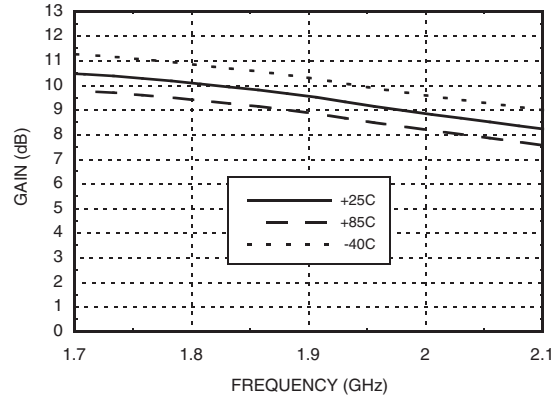




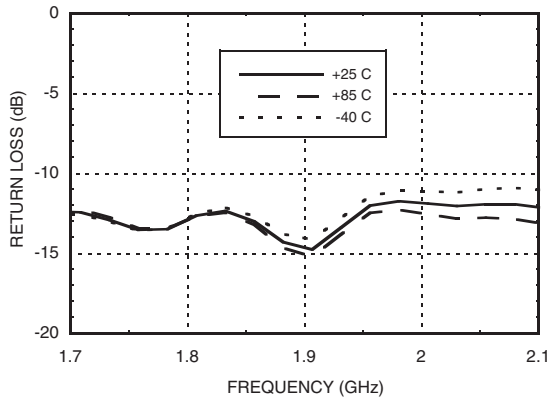
Broadband Gain & Return Loss @ 1900 MHz



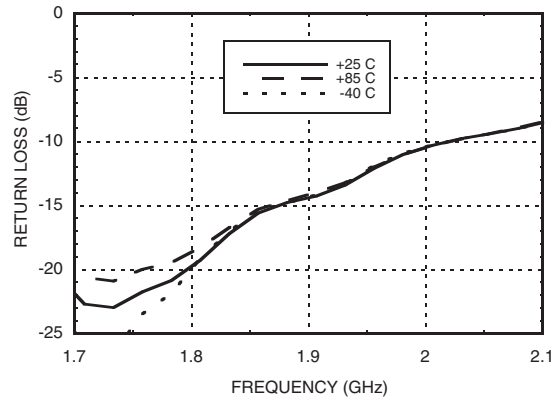
Gain vs. Temperature @ 1900 MHz



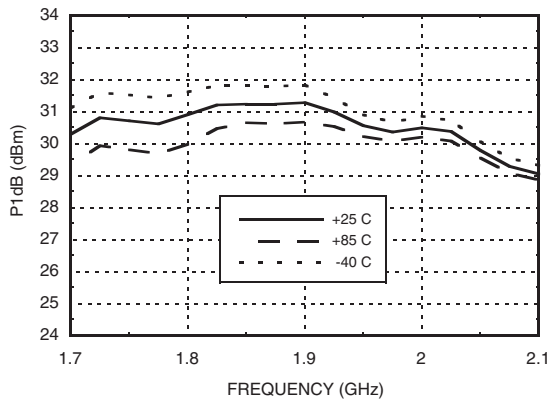
Input Return Loss vs. Temperature @ 1900 MHz



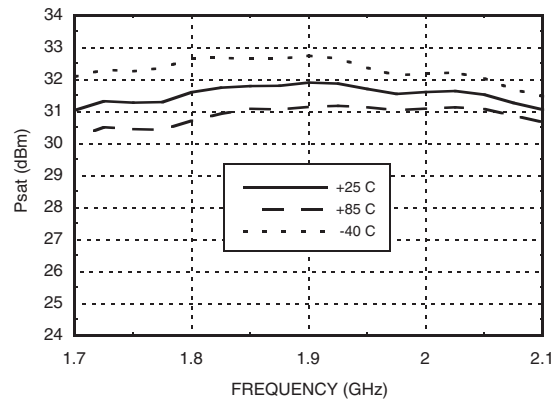
Output Return Loss vs. Temperature @ 1900 MHz



P1dB vs. Temperature @ 1900 MHz



Psat vs. Temperature @ 1900 MHz





Output IP3 vs. Temperature @ 1900 MHz



Noise Figure vs. Temperature @ 1900 MHz



Reverse Isolation vs. Temperature @ 1900 MHz



Gain, Power & IP3 vs. Supply Voltage @ 1900 MHz



Power Compression @ 1900 MHz



ACPR vs. Supply Voltage @ 1960 MHz CDMA 2000, 9 Channels Forward





Broadband Gain & Return Loss @ 2100 MHz



Gain vs. Temperature @ 2100 MHz



Input Return Loss vs. Temperature @ 2100 MHz



Output Return Loss vs. Temperature @ 2100 MHz



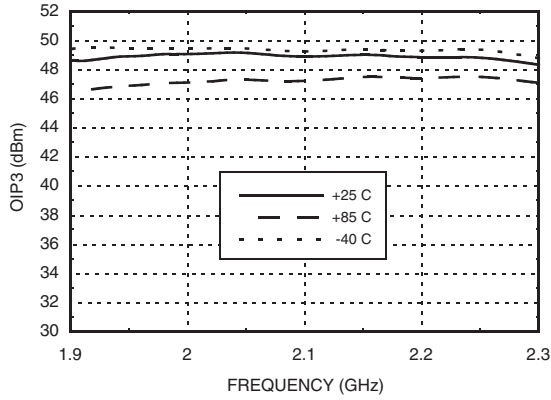
P1dB vs. Temperature @ 2100 MHz



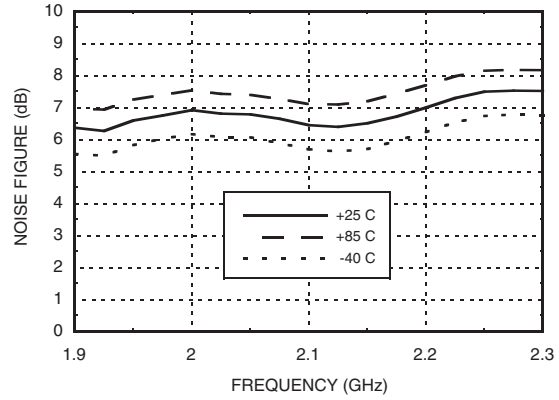
Psat vs. Temperature @ 2100 MHz



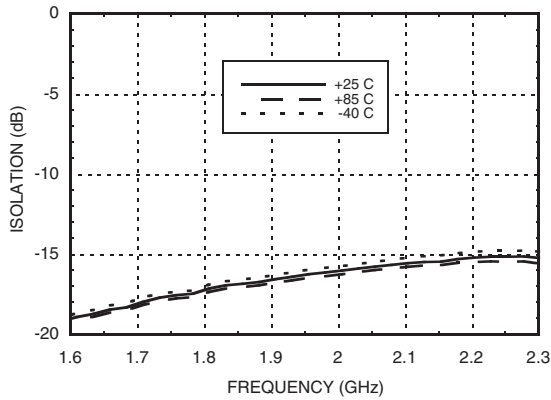
Output IP3 vs. Temperature @ 2100 MHz



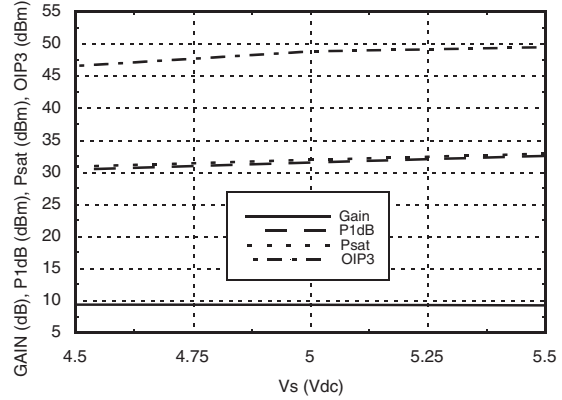
Noise Figure vs. Temperature @ 2100 MHz



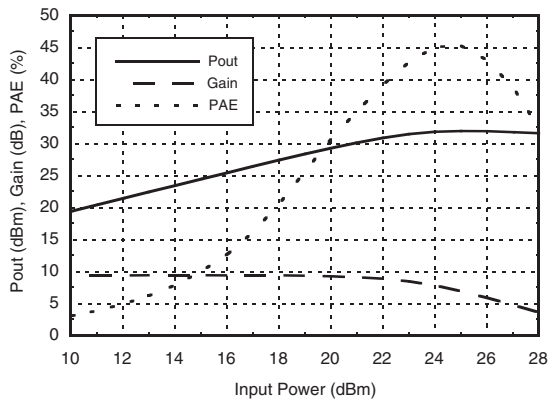
Reverse Isolation vs. Temperature @ 2100 MHz



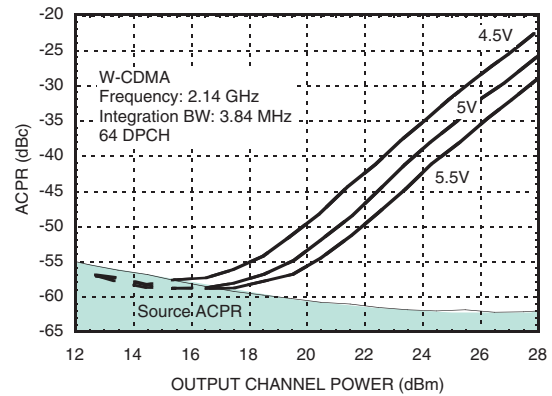
Gain, Power & IP3 vs. Supply Voltage @ 2100 MHz



Power Compression @ 2100 MHz



ACPR vs. Supply Voltage @ 2140 MHz W-CDMA, 64 DPCH



Power Dissipation



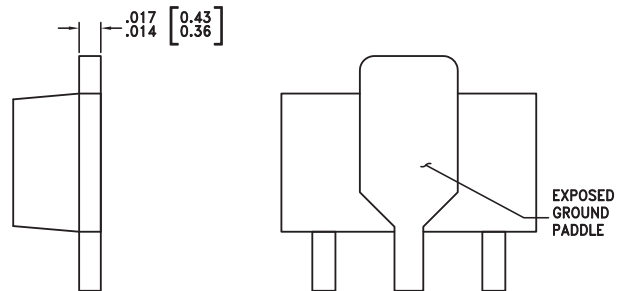
Absolute Maximum Ratings

| | |
|--|----------------|
| Collector Bias Voltage (Vcc) | +6.0 Vdc |
| RF Input Power (RFIN)(Vs +5Vdc) | +31 dBm |
| Junction Temperature | 150 °C |
| Continuous Pdis (T = 85 °C) (derate 41.5 mW/°C above 85 °C) | 2.7 W |
| Thermal Resistance (junction to ground paddle) | 24.1 °C/W |
| Storage Temperature | -65 to +150 °C |
| Operating Temperature | -40 to +85 °C |
| ESD Sensitivity (HBM) | Class 1A |



ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

Outline Drawing



NOTES:

- PACKAGE BODY MATERIAL:
MOLDING COMPOUND MP-180S OR EQUIVALENT.
- LEAD MATERIAL: Cu w/ Ag SPOT PLATING.
- LEAD PLATING: 100% MATTE TIN.
- DIMENSIONS ARE IN INCHES [MILLIMETERS]
- Δ DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
- Δ DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
- ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

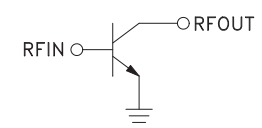

| Part Number | Package Body Material | Lead Finish | MSL Rating | Package Marking ^[3] |
|-------------|--|---------------|---------------------|--------------------------------|
| HMC452ST89 | Low Stress Injection Molded Plastic | Sn/Pb Solder | MSL1 ^[1] | H452 XXXX |
| HMC452ST89E | RoHS-compliant Low Stress Injection Molded Plastic | 100% matte Sn | MSL1 ^[2] | H452 XXXX |

[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

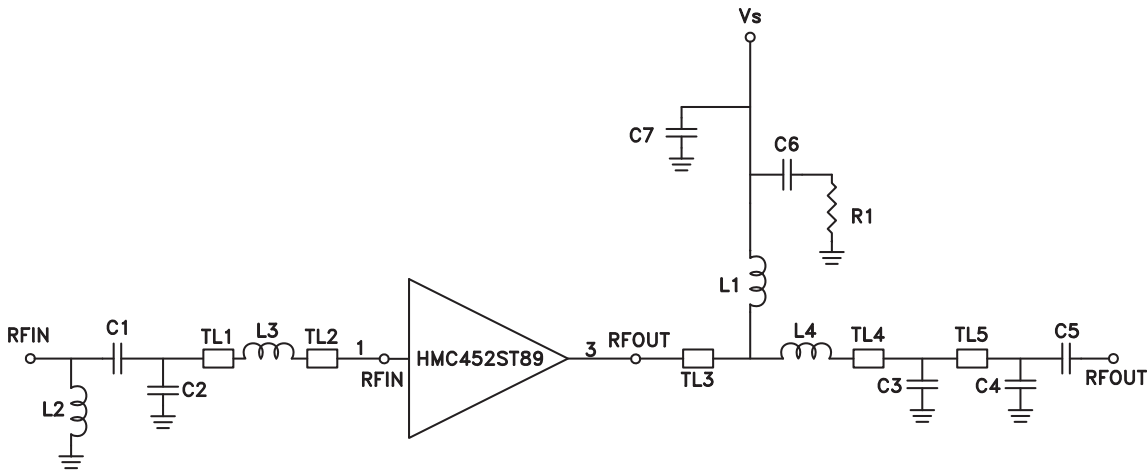
[3] 4-Digit lot number XXXX

Pin Descriptions

| Pin Number | Function | Description | Interface Schematic |
|------------|----------|--|---|
| 1 | RFIN | This pin is DC coupled. Off chip matching components are required. See Application Circuit herein. |  |
| 3 | RFOUT | RF output and DC Bias input for the output amplifier stage. Off chip matching components are required. See Application Circuit herein. | |
| 2, 4 | GND | These pins & package bottom must be connected to RF/DC ground. |  |

400 MHz Application Circuit

This circuit was used to specify the performance for 400-410 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.



Note: C2 should be placed as close to pins as possible.

| | TL1 | TL2 | TL3 | TL4 | TL5 |
|---|--------|--------|--------|--------|--------|
| Impedance | 50 Ohm | 50 Ohm | 50 Ohm | 50 Ohm | 50 Ohm |
| Physical Length | 0.09" | 0.08" | 0.17" | 0.04" | 0.25" |
| Electrical Length | 2° | 2° | 4° | 1° | 6° |
| PCB Material: 10 mil Rogers 4350, Er = 3.48 | | | | | |

| Recommended Component Values | |
|------------------------------|---------|
| C1 | 12 pF |
| C2 | 15 pF |
| C3, C4 | 6.8 pF |
| C5 | 39 pF |
| C6 | 100 pF |
| C7 | 2.2 μF |
| L1 | 47 nH |
| L2 | 40 nH |
| L3 | 4.3 nH |
| L4 | 5.1 nH |
| R1 | 5.1 Ohm |

400 MHz Evaluation PCB



List of Materials for Evaluation PCB 110409-400 [1]

| Item | Description |
|---------|-------------------------------------|
| J1 - J2 | PCB Mount SMA Connector |
| J3 | 2 mm DC Header |
| C1 | 12 pF Capacitor, 0402 Pkg. |
| C2 | 15 pF Capacitor, 0402 Pkg. |
| C3, C4 | 6.8 pF Capacitor, 0402 Pkg. |
| C5 | 39 pF Capacitor, 0402 Pkg. |
| C6 | 100 pF Capacitor, 0402 Pkg. |
| C7 | 2.2 μF Capacitor, Tantalum |
| L1 | 47 nH Inductor, 0603 Pkg. |
| L2 | 40 nH Inductor, 0402 Pkg. |
| L3 | 4.3 nH Inductor, 0402 Pkg. |
| L4 | 5.1 nH Inductor, 0402 Pkg. |
| R1 | 5.1 Ohm Resistor, 0402 Pkg. |
| U1 | HMC452ST89 / HMC452ST89E Linear Amp |
| PCB [2] | 110407 Evaluation PCB, 10 mils |

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350, Er = 3.48

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

470 MHz Application Circuit

This circuit was used to specify the performance for 450-496 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.

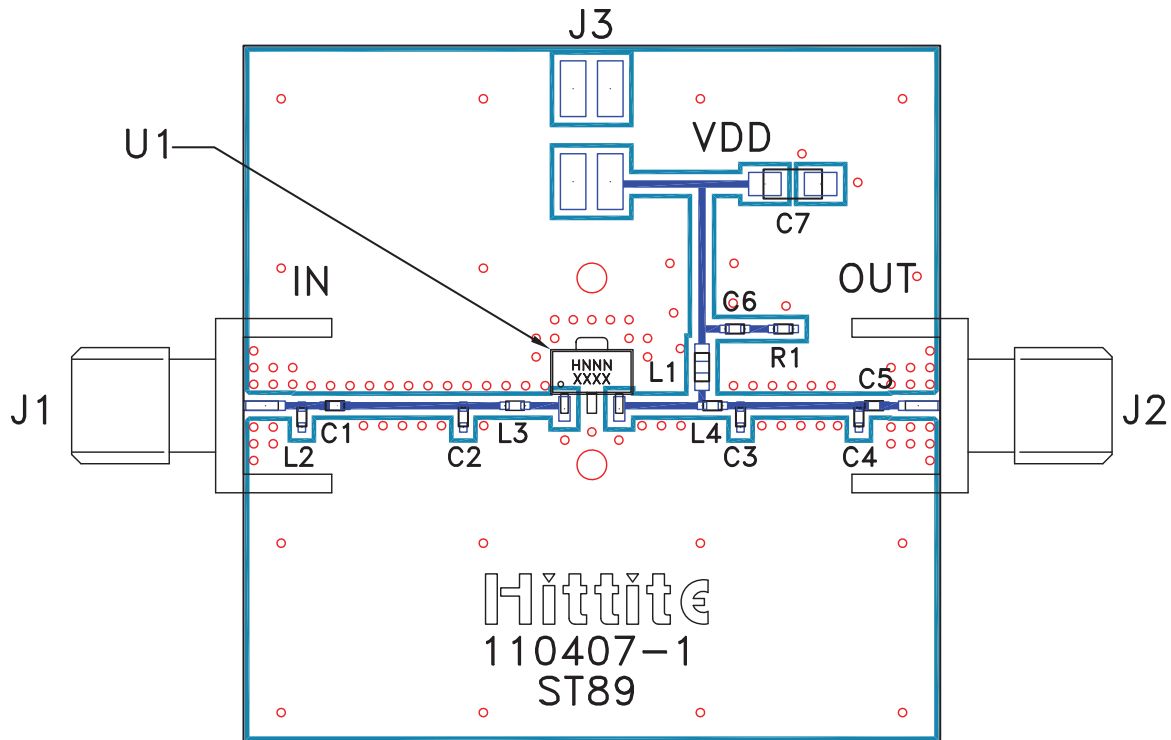


Note: C2 should be placed as close to pins as possible.

| | TL1 | TL2 | TL3 | TL4 | TL5 |
|---|--------|--------|--------|--------|--------|
| Impedance | 50 Ohm | 50 Ohm | 50 Ohm | 50 Ohm | 50 Ohm |
| Physical Length | 0.09" | 0.08" | 0.17" | 0.04" | 0.25" |
| Electrical Length | 2.5° | 2° | 5° | 1° | 7° |
| PCB Material: 10 mil Rogers 4350, Er = 3.48 | | | | | |

| Recommended Component Values | |
|------------------------------|---------|
| C1, C2 | 12 pF |
| C3 | 6.8 pF |
| C4 | 5.6 pF |
| C5 | 39 pF |
| C6 | 100 pF |
| C7 | 2.2 μF |
| L1 | 47 nH |
| L2 | 40 nH |
| L3 | 4.7 nH |
| L4 | 3.9 nH |
| R1 | 5.1 Ohm |

470 MHz Evaluation PCB



List of Materials for Evaluation PCB 110416-470 [1]

| Item | Description |
|---------|-------------------------------------|
| J1 - J2 | PCB Mount SMA Connector |
| J3 | 2 mm DC Header |
| C1, C2 | 12 pF Capacitor, 0402 Pkg. |
| C3 | 6.8 pF Capacitor, 0402 Pkg. |
| C4 | 5.6 pF Capacitor, 0402 Pkg. |
| C5 | 39 pF Capacitor, 0402 Pkg. |
| C6 | 100 pF Capacitor, 0402 Pkg. |
| C7 | 2.2 μ F Capacitor, Tantalum |
| L1 | 47 nH Inductor, 0603 Pkg. |
| L2 | 40 nH Inductor, 0402 Pkg. |
| L3 | 4.7 nH Inductor, 0402 Pkg. |
| L4 | 3.9 nH Inductor, 0402 Pkg. |
| R1 | 5.1 Ohm Resistor, 0402 Pkg. |
| U1 | HMC452ST89 / HMC452ST89E Linear Amp |
| PCB [2] | 110407 Evaluation PCB, 10 mils |

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350, Er = 3.48

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.



900 MHz Application Circuit

This circuit was used to specify the performance for 810-960 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.



Note: C2 should be placed as close to pins as possible.

| | TL1 | TL2 | TL3 |
|---|--------|--------|--------|
| Impedance | 50 Ohm | 50 Ohm | 50 Ohm |
| Physical Length | 0.21" | 0.13" | 0.38" |
| Electrical Length | 11° | 7° | 20° |
| PCB Material: 10 mil Rogers 4350, Er = 3.48 | | | |

| Recommended Component Values | |
|------------------------------|---------|
| C1 | 27 pF |
| C2 | 6.8 pF |
| C3 | 2.2 pF |
| C4 | 4.7 pF |
| C5 | 5.6 pF |
| C6 | 100 pF |
| C7 | 2.2 μF |
| L1 | 20 nH |
| R1 | 5.1 Ohm |

900 MHz Evaluation PCB



List of Materials for Evaluation PCB 110384-900 ^[1]

| Item | Description |
|--------------------|--|
| J1 - J2 | PCB Mount SMA Connector |
| J3 | 2 mm DC Header |
| C1 | 27 pF Capacitor, 0402 Pkg. |
| C2 | 6.8 pF Capacitor, 0402 Pkg. |
| C3 | 2.2 pF Capacitor, 0402 Pkg. |
| C4 | 4.7 pF Capacitor, 0402 Pkg. |
| C5 | 5.6 pF Capacitor, 0402 Pkg. |
| C6 | 100 pF Capacitor, 0402 Pkg. |
| C7 | 2.2 μ F Capacitor, Tantalum |
| L1 | 20 nH Inductor, 0402 Pkg. |
| R1 | 5.1 Ohm Resistor, 0402 Pkg. |
| U1 | HMC452ST89 / HMC452ST89E Linear Amp |
| PCB ^[2] | 110382 Evaluation PCB, 10 mils |

[1] Reference this number when ordering complete evaluation PCB

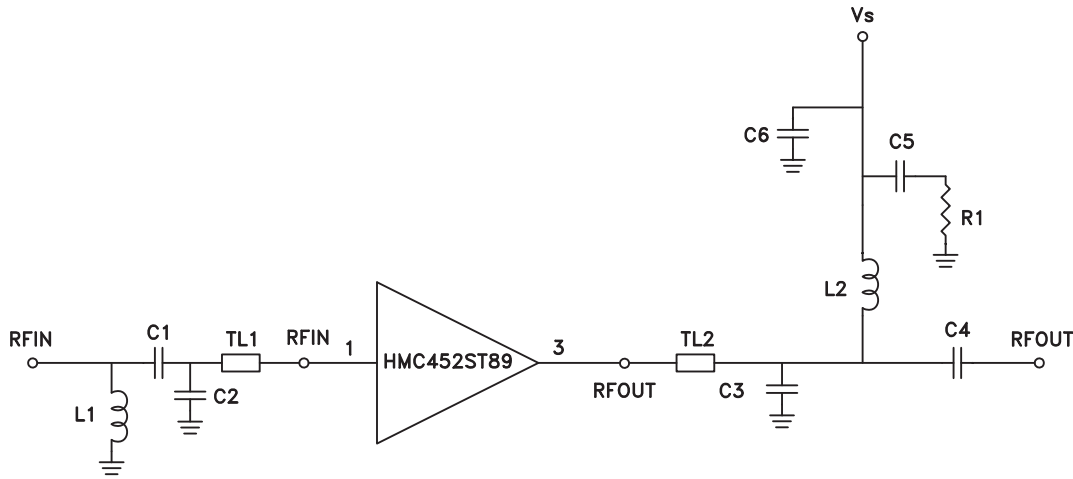
[2] Circuit Board Material: Rogers 4350, Er = 3.48

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.



1900 MHz Application Circuit

This circuit was used to specify the performance for 1710-1990 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.



Note: C2 should be placed as close to pins as possible.

| | TL1 | TL2 |
|---|--------|--------|
| Impedance | 50 Ohm | 50 Ohm |
| Physical Length | 0.04" | 0.10" |
| Electrical Length | 4° | 11° |
| PCB Material: 10 mil Rogers 4350, Er = 3.48 | | |

| Recommended Component Values | |
|------------------------------|---------|
| C1 | 3 pF |
| C2 | 2 pF |
| C3 | 3.3 pF |
| C4 | 15 pF |
| C5 | 100 pF |
| C6 | 2.2 μF |
| L1 | 10 nH |
| L2 | 12 nH |
| R1 | 5.1 Ohm |



1900 MHz Evaluation PCB



List of Materials for Evaluation PCB 108712-1900 [1]

| Item | Description |
|---------|-------------------------------------|
| J1 - J2 | PCB Mount SMA Connector |
| J3 | 2 mm DC Header |
| C1 | 3 pF Capacitor, 0402 Pkg. |
| C2 | 2 pF Capacitor, 0402 Pkg. |
| C3 | 3.3 pF Capacitor, 0402 Pkg. |
| C4 | 15 pF Capacitor, 0402 Pkg. |
| C5 | 100 pF Capacitor, 0402 Pkg. |
| C6 | 2.2 μ F Capacitor, Tantalum |
| L1 | 10 nH Inductor, 0402 Pkg. |
| L2 | 12 nH Inductor, 0402 Pkg. |
| R1 | 5.1 Ohm Resistor, 0402 Pkg. |
| U1 | HMC452ST89 / HMC452ST89E Linear Amp |
| PCB [2] | 108710 Evaluation PCB, 10 mils |

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350, Er = 3.48

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.



2100 MHz Application Circuit

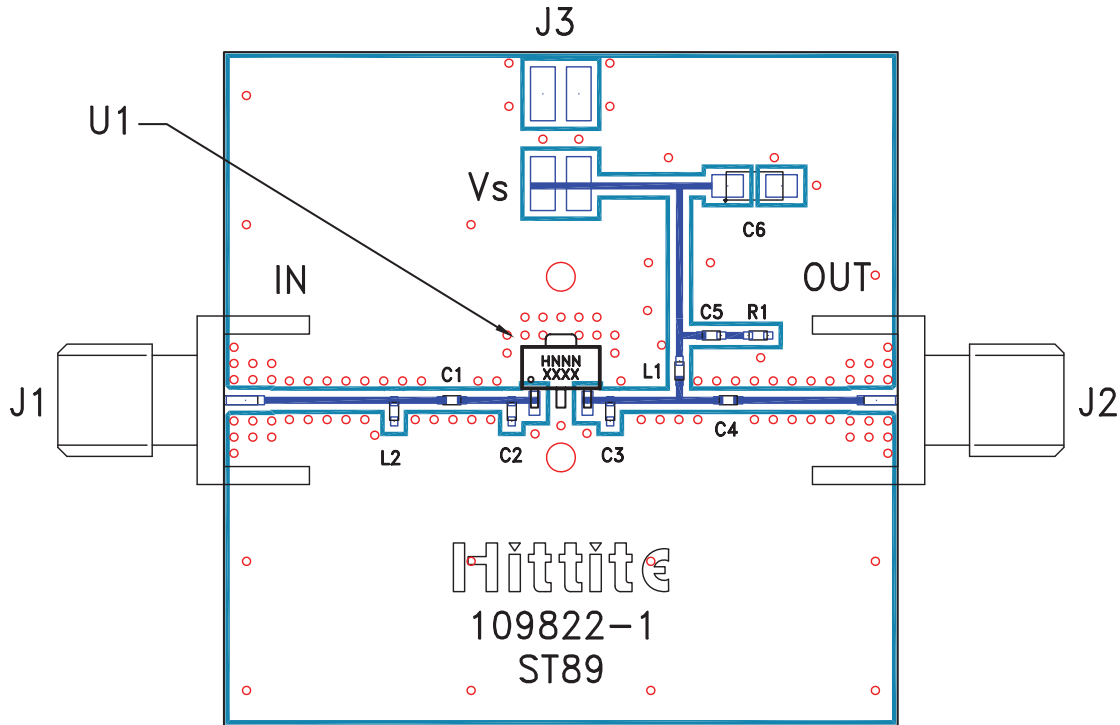
This circuit was used to specify the performance for 2010-2170 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.



| | TL1 | TL2 |
|---|--------|--------|
| Impedance | 50 Ohm | 50 Ohm |
| Physical Length | 0.04" | 0.04" |
| Electrical Length | 5° | 5° |
| PCB Material: 10 mil Rogers 4350, Er = 3.48 | | |

| Recommended Component Values | |
|------------------------------|---------|
| C1 | 3 pF |
| C2 | 2 pF |
| C3 | 3.3 pF |
| C4 | 15 pF |
| C5 | 100 pF |
| C6 | 2.2 μF |
| L1 | 12 nH |
| L2 | 10 nH |
| R1 | 5.1 Ohm |

2100 MHz Evaluation PCB



List of Materials for Evaluation PCB 109824-2100 [1]

| Item | Description |
|---------|-------------------------------------|
| J1 - J2 | PCB Mount SMA Connector |
| J3 | 2 mm DC Header |
| C1 | 3 pF Capacitor, 0402 Pkg. |
| C2 | 2 pF Capacitor, 0402 Pkg. |
| C3 | 3.3 pF Capacitor, 0402 Pkg. |
| C4 | 15 pF Capacitor, 0402 Pkg. |
| C5 | 100 pF Capacitor, 0402 Pkg. |
| C6 | 2.2 μ F Capacitor, Tantalum |
| L1 | 12 nH Inductor, 0402 Pkg. |
| L2 | 10 nH Inductor, 0402 Pkg. |
| R1 | 5.1 Ohm Resistor, 0402 Pkg. |
| U1 | HMC452ST89 / HMC452ST89E Linear Amp |
| PCB [2] | 109822 Evaluation PCB, 10 mils |

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350, Er = 3.48

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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